

DMNH6021SPSWQ

60V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max Tc = +25°C
	23mΩ @ V _{GS} = 10V	44A
60V	28mΩ @ V _{GS} = 4.5V	40A

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Backlighting
- Power Management Functions
- DC-DC Converters

Features and Benefits

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switch (UIS) Test in Production
- High Conversion Efficiency
- Low RDS(ON) Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMNH6021SPSWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/guality/product-definitions/

Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (3)

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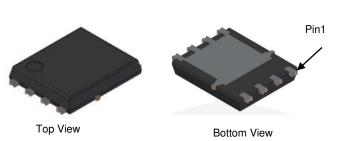
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Weight: 0.097 grams (Approximate)

S

Internal Schematic



Ordering Information (Note 4)

Part Number	Case	Packaging
DMNH6021SPSWQ-13	PowerDI5060-8 (SWP) (Type UX)	2,500 / Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

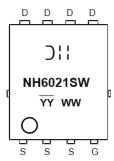
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

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3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



PowerDI is a registered trademark of Diodes Incorporated. DMNH6021SPSWQ Document number: DS40459 Rev. 4 - 2

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ПD

0 0 0

Πр

Top View

Pin Configuration

PowerDI5060-8 (SWP) (Type UX)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		VDSS	60	V
Gate-Source Voltage		V _{GSS}	±20	V
Continuous Drain Current, V _{GS} = 10V (Note 7)	Tc = +25°C Tc = +100°C	ID	44 31	А
Maximum Continuous Body Diode Forward Current (Note	7)	ls	44	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	ldм	176	А	
Pulsed Source Current (10µs Pulse, Duty Cycle = 1%)		lsм	176	А
Avalanche Current, L = 0.1mH		las	35.7	А
Avalanche Energy, L = 0.1mH		Eas	64	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	1.6	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	96	°C/W
Total Power Dissipation (Note 6)		PD	3.0	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{0JA}	50	°C/W
Total Power Dissipation (Note 7)		PD	100	W
Thermal Resistance, Junction to Case (Note 7)	Steady State	Rejc	1.5	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BVDSS	60	—	—	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	IDSS		_	1	μA	$V_{DS} = 60V, V_{GS} = 0V$	
Gate-Source Leakage	lgss	_	—	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	1	_	3	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Resistance	Proven		12	23	mΩ	$V_{GS} = 10V, I_{D} = 12A$	
	R _{DS(ON)}		20	28	11122	$V_{GS} = 4.5V, I_{D} = 12A$	
Diode Forward Voltage	VSD		0.75	1.2	V	$V_{GS} = 0V$, $I_S = 20A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss		1,132	—			
Output Capacitance	Coss		157	-	pF		
Reverse Transfer Capacitance	Crss		75	-			
Gate Resistance	Rg		2.5	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge ($V_{GS} = 4.5V$)	Qg		9.7	-		V 00V/ I 00A	
Total Gate Charge (V _{GS} = 10V)	Qg	_	20.1	—			
Gate-Source Charge	Q _{gs}	_	4.3	—	nC	$V_{DS} = 30V, I_{D} = 20A$	
Gate-Drain Charge	Q _{gd}	_	5.5	—			
Turn-On Delay Time	tD(ON)	_	4.4	—		$\label{eq:VDD} \begin{split} V_{DD} &= 30V, \ V_{GS} = 10V, \\ I_D &= 20A, \ R_G = 4.7\Omega \end{split}$	
Turn-On Rise Time	t _R	_	6.0	—			
Turn-Off Delay Time	tD(OFF)		14.2	—	ns		
Turn-Off Fall Time	tF	_	5.4	—			
Body Diode Reverse Recovery Time	trr		21.2	—	ns		
Body Diode Reverse Recovery Charge	Qrr		15.2	—	nC	— IF = 20A, di/dt = 100A/μs	

Notes:

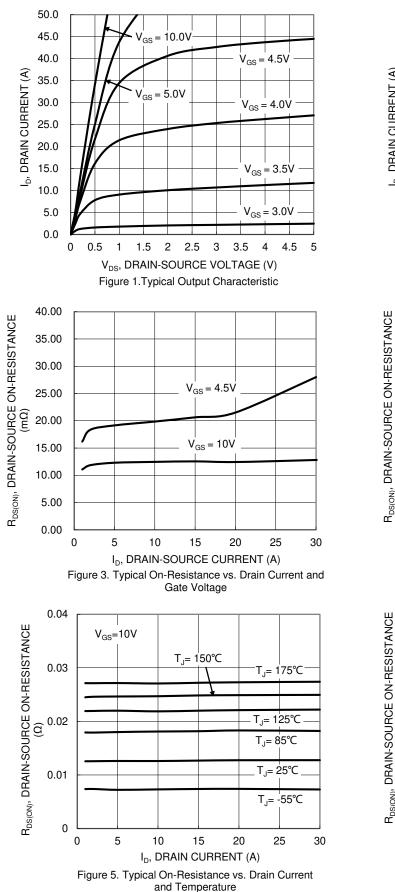
Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

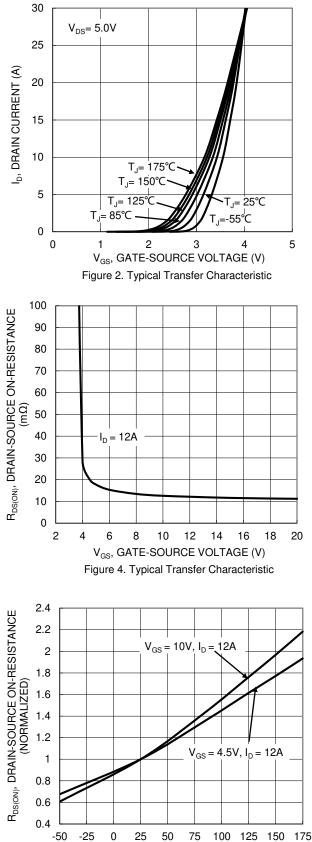
Thermal resistance from junction to soldering point (on the exposed drain pad).
Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.

DMNH6021SPSWQ



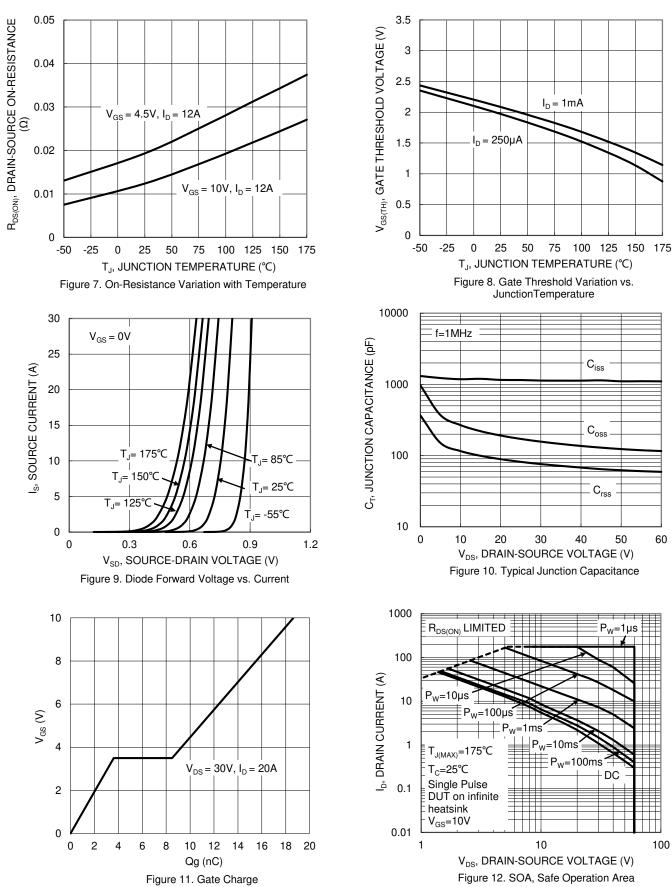




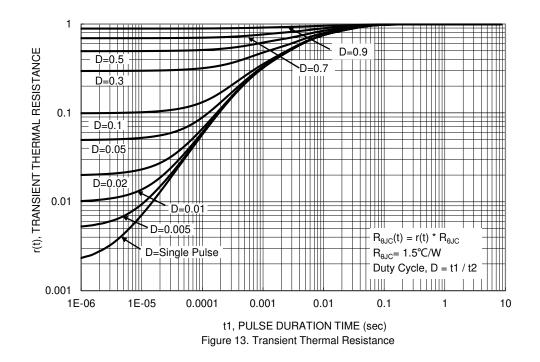
T_J, JUNCTION TEMPERATURE (°C) Figure 6. On-Resistance Variation with Temperature



DMNH6021SPSWQ









PowerDI5060-8 (SWP)

(Type UX) Min

0.20 0.35

4.70 5.10

4.195 4.595

0.635 0.835

0.635 0.835

0.200 0.400

0.025 0.225

All Dimensions in mm

0.90

0

0.30

3.56

3.78

5.60

3.46

1.05

3.205

10°

6°

С

е

k

θ

Max

1.10

0.05

0.50

0.25REF

0.230 0.330 0.277

3.96

4.18

6.00

3.86

1.27BS0

0.050REF

4.005

12°

8°

6.40 BS0

5.15 BS

Тур

1.00

0.41

0.25

4.90

3.76

3.98

5.80

3.66

4.395

0.735

0.735

0.300

0.125

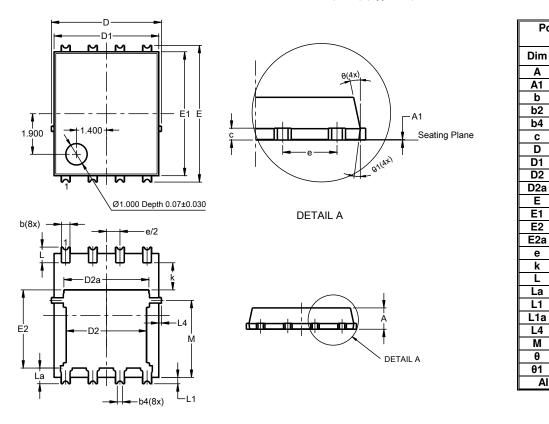
3.605

11°

7°

Package Outline Dimensions

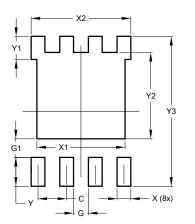
Please see http://www.diodes.com/package-outlines.html for the latest version.



PowerDI5060-8 (SWP) (Type UX)

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	4.100		
X2	4.420		
Y	1.270		
¥1	1.020		
Y2	3.810		
Y3	6.610		

PowerDI5060-8 (SWP) (Type UX)



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